30V P-Channel Enhancement Mode MOSFET

Description

The NP3007DR uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 1.8V. This device is suitable for use as a load switch or in PWM applications.

General Features

- V_{DS} =-30V，I_D =-7A
  $R_{DS(ON)}$(Typ.)=28mΩ @V_{GS}=-10V
  $R_{DS(ON)}$(Typ.)=36mΩ @V_{GS}=-4.5V
- High power and current handing capability
- Lead free product is acquired
- Surface mount package

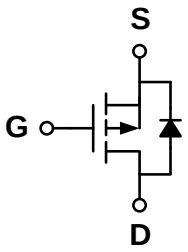
Application

- PWM applications
- Load switch

Package

- DFN2*2-6L-B

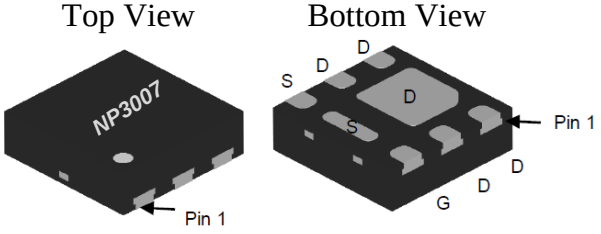
Schematic diagram



Marking and pin assignment

DFN2*2-6L-B

（Thickness 0.55mm）



NP----Natlinear Power

3007----NP3007

Ordering Information

Part Number	Storage Temperature	Package	Devices Per Reel
NP3007DR-G	-55°C to +150°C	DFN2*2-6L-B	4000

Absolute Maximum Ratings (TA=25℃ unless otherwise noted)

parameter	symbol	limit	unit
Drain-source voltage	V_{DS}	-30	V
Gate-source voltage	V_{GS}	±20	V
Drain current-continuous[a]@Tj=125℃	I_D	-7	A
-pulse *d*[b]	I_{DM}	-28	A
Drain-source Diode forward current	Is	-7	A
Maximum power dissipation	P_D	18	W
Operating junction Temperature range	Tj	-55—150	℃

Electrical Characteristics (TA=25℃ unless otherwise noted)

Parameter	Symbol	Condition	Min	Typ	Max	Unit
OFF Characteristics						
Drain-source breakdown voltage	BV_{DSS}	V_{GS}=0V, I_D=-250μA	-30	-	-	V
Zero gate voltage drain current	I_{DSS}	V_{DS}=-30V, V_{GS}=0V	-	-	-1	μA
Gate-body leakage	I_{GSS}	V_{DS}=0V, V_{GS}=±20V	-	-	±100	nA
ON Characteristics						
Gate threshold voltage	$V_{GS(th)}$	V_{DS}=V_{GS}, I_D=-250μA	-0.8	-1.3	-2	V
Drain-source on-state resistance	$R_{DS(ON)}$	V_{GS}=-10V, I_D=-7A	-	28	35	mΩ
		V_{GS}=-4.5V, I_D=-5A	-	36	45	
Forward transconductance	gfs	V_{GS}=-5V, I_D=-7A	-	5	-	S
Dynamic Characteristics						
Input capacitance	C_{ISS}	V_{DS}=-15V ,V_{GS}=0V f=1.0MHz	-	949	-	pF
Output capacitance	C_{OSS}		-	100	-	
Reverse transfer capacitance	C_{RSS}		-	80	-	
Switching Characteristics						
Turn-on delay time	$t_{D(ON)}$	V_{DS}=-15V V_{GS}=-10V R_L=2.3Ω R_{GEN}=3Ω	-	8	-	ns
Rise time	tr		-	6	-	
Turn-off delay time	$t_{D(OFF)}$		-	17	-	
Fall time	tf		-	5	-	
Total gate charge	Qg	V_{DS}=-15V,I_D=-7A V_{GS}=-10V	-	17.9	-	nC
Gate-source charge	Qgs		-	2.7	-	
Gate-drain charge	Qgd		-	2.5	-	
DRAIN-SOURCE DIODE CHARACTERISTICS						
Diode forward voltage	V_{SD}	V_{GS}=0V,Is=-1.25A	-	-0.81	-1.2	V

Notes:

a. surface mounted on FR4 board,t≤10sec

b. pulse test: pulse width≤300μs,duty≤2%

c. guaranteed by design, not subject to production testing

Thermal Characteristics

Thermal Resistance junction-to ambient	Rth JA	100	℃/W

Typical Electrical And Thermal Characteristics

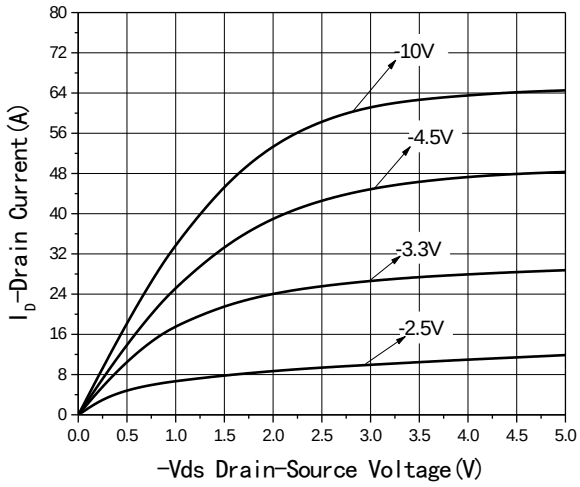


Fig1 Output Characteristics

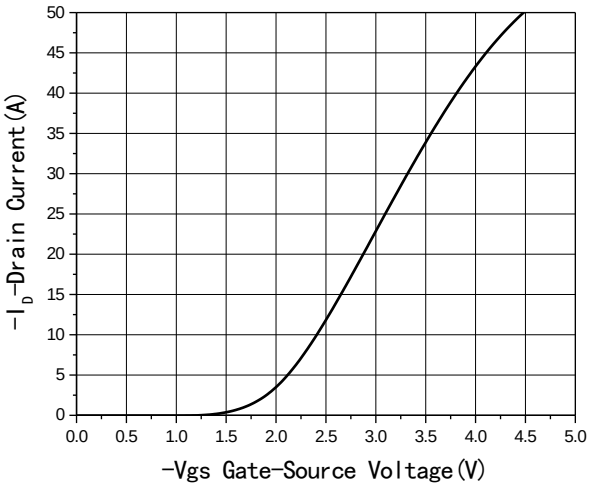


Fig2 Transfer Characteristics

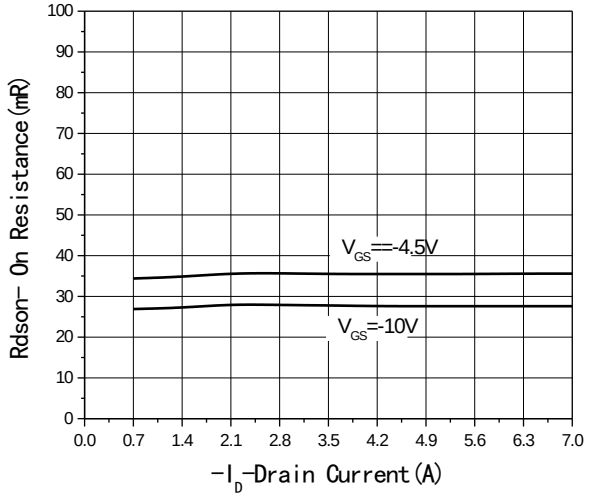


Fig3 Rdson-Drain current

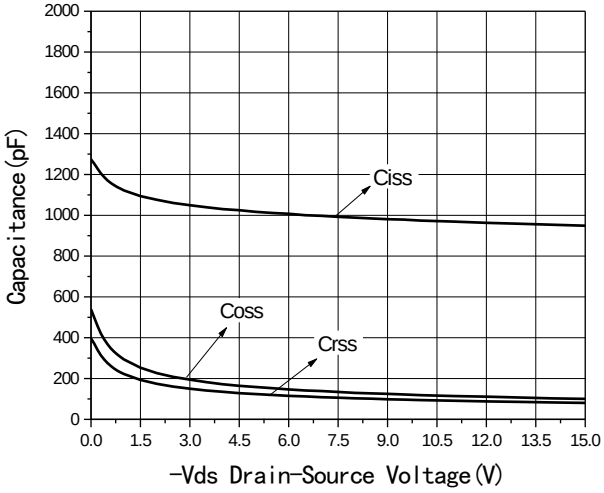


Fig4 Capacitance vs Vds

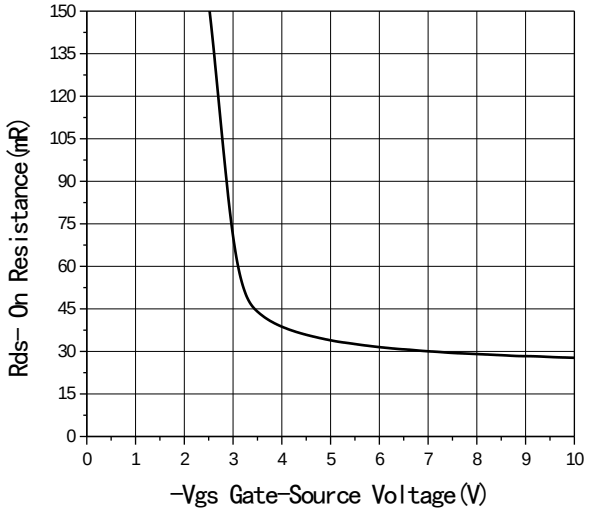


Fig5 Rdson-Gate Drain voltage

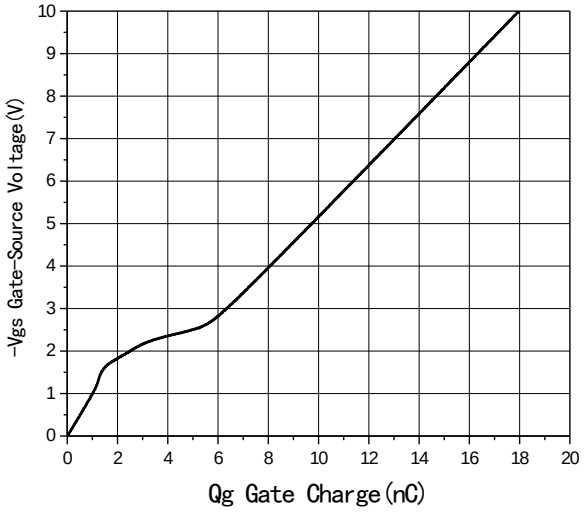


Fig6 Gate Charge

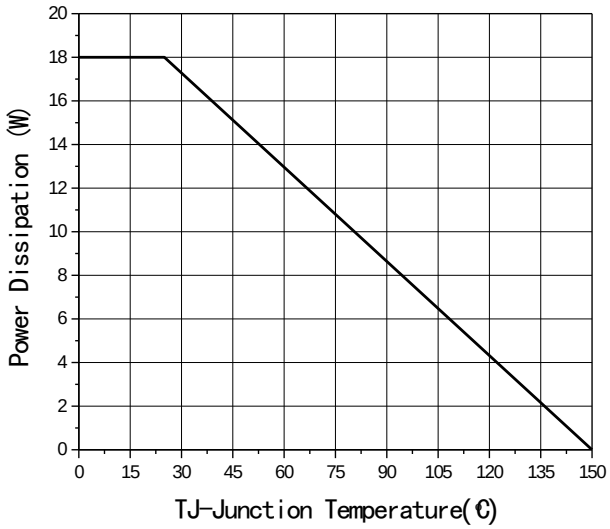


Fig7 Power De-rating

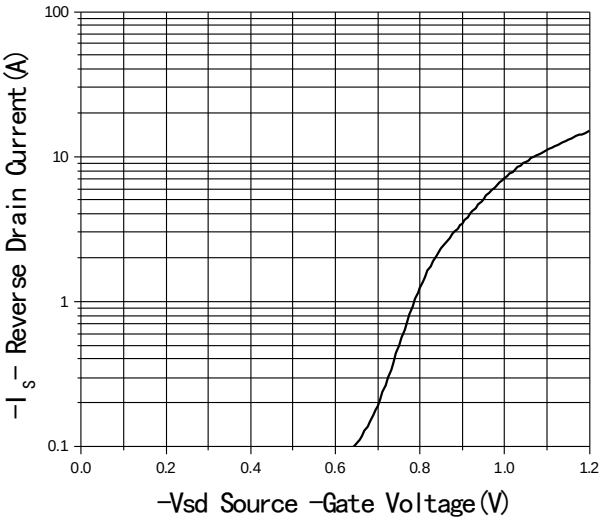
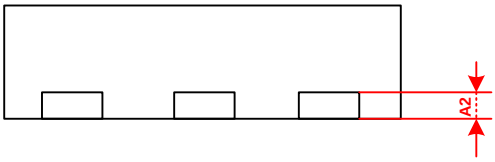


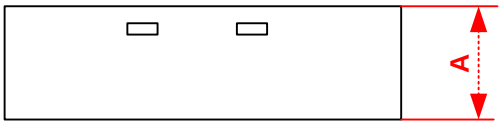
Fig8 Source-Drain Diode Forward

Package Information

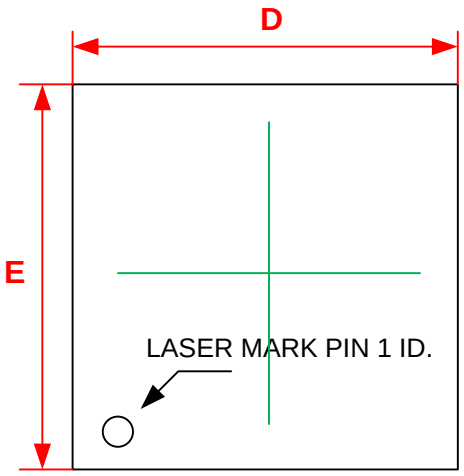
- **DFN2*2-6L-B**



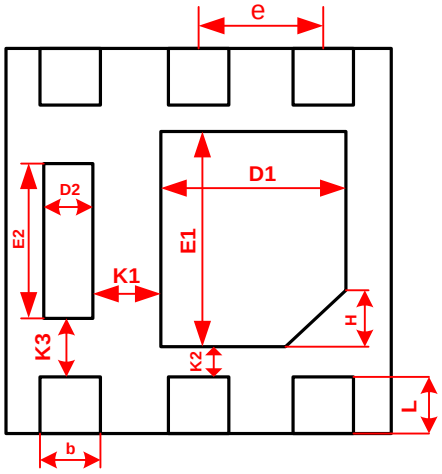
SIDE VIEW



SIDE VIEW



TOP VIEW



BOTTOM VIEW

Common Dimension （mm）			
PKG	DFN2020-6L-B		
SYMBOL	MIN.	MON.	MAX.
A	0.527	0.552	0.577
A2		0.127REF	
b	0.25	0.30	0.35
D	1.90	2.00	2.10
E	1.90	2.00	2.10
D1	0.85	0.95	1.05
E1	1.05	1.15	1.25
D2	0.20	0.25	0.30
E2	0.69	0.79	0.89
e	0.55	0.65	0.75
H	0.25	0.30	0.35
K1	0.25MIN		
K2	0.15MIN		
K3	0.20MIN		
L	0.20	0.25	0.30